Smart Highside High Current Power Switch Reversave™

Features
- Overload protection
- Current limitation
- Short circuit protection
- Over temperature protection
- Over voltage protection (including load dump)
- Clamp of negative voltage at output
- Fast deenergizing of inductive loads [1]
- Low ohmic inverse current operation
- **Reversave™** (Reverse battery protection)
- Diagnostic feedback with load current sense
- Open load detection via current sense
- Loss of V_{bb} protection [2]
- **E**lectro**s**tatic **d**ischarge (**ESD**) protection
- Green product (RoHS compliant)
- AEC qualified

Application
- Power switch with current sense diagnostic feedback for 12 V DC grounded loads
- Most suitable for loads with high inrush current like lamps and motors; all types of resistive and inductive loads
- Replaces electromechanical relays, fuses and discrete circuits

Product Summary

Overvoltage protection	$V_{bb(AZ)}$	62	V
Output clamp	$V_{ON(CL)}$	42	V
Operating voltage	$V_{bb(on)}$	5.0 ... 34	V
On-state resistance	R_{ON}	6.0	mΩ
Load current (ISO)	$I_{L(ISO)}$	70	A
Short circuit current limitation	$I_{L(SC)}$	130	A
Current sense ratio	$I_L : I_{IS}$	14 000	

PG-TO220-7-11
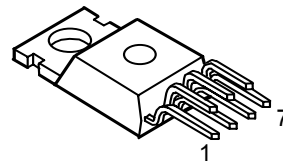
Standard

General Description
N channel vertical power FET with charge pump, current controlled input and diagnostic feedback with load current sense, integrated in Smart SIPMOS® chip on chip technology. Providing embedded protective functions.

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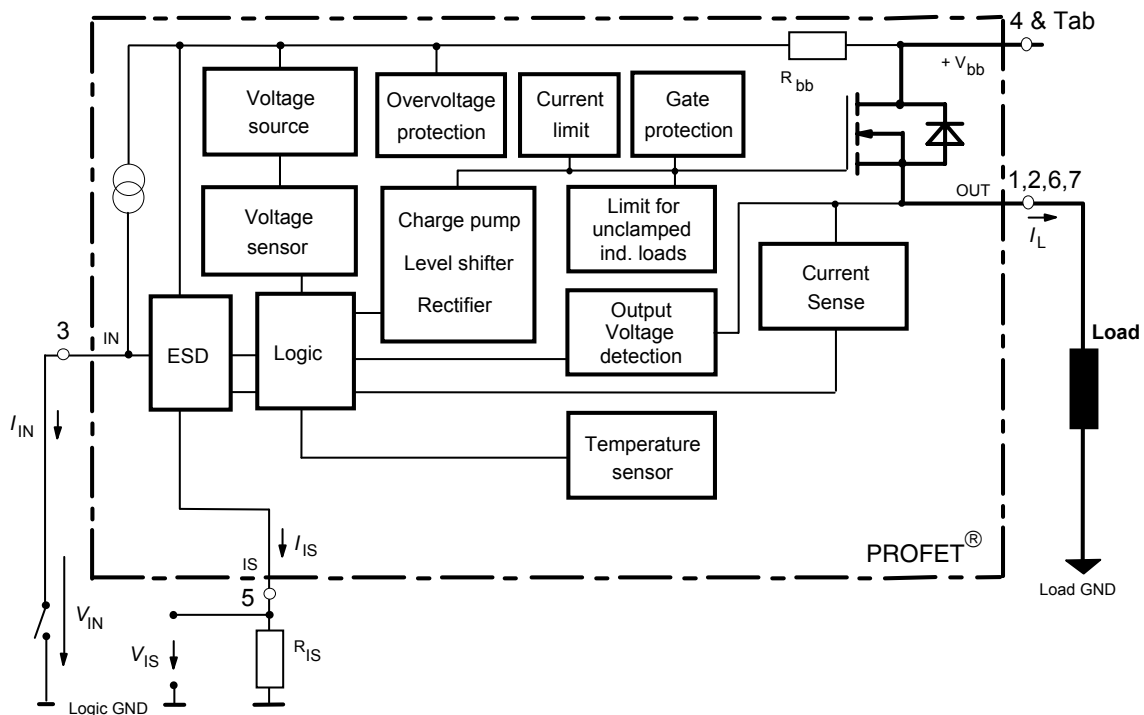
[1] With additional external diode.
[2] Additional external diode required for energized inductive loads (see page 9).

Pin	Symbol		Function
1	OUT	O	**Output**; output to the load; pin 1, 2, 6 and 7 must be externally shorted with each other especially in high current applications. [3]
2	OUT	O	**Output**; output to the load; pin 1, 2, 6 and 7 must be externally shorted with each other especially in high current applications. [3]
3	IN	I	**Input**; has an internal pull up; activates the power switch in case of short to ground
4	Vbb	+	**Supply voltage**; positive power supply voltage; tab and pin 4 are internally shorted; in high current applications use the tab [4].
5	IS	S	**Sense Output**; Diagnostic feedback; provides a sense current proportional to the load current; zero current on failure (see Truth Table on page 7)
6	OUT	O	**Output**; output to the load; pin 1, 2, 6 and 7 must be externally shorted with each other especially in high current applications. [3]
7	OUT	O	**Output**; output to the load; pin 1, 2, 6 and 7 must be externally shorted with each other especially in high current applications. [3]

Maximum Ratings at T_j = 25 °C unless otherwise specified

Parameter	Symbol	Values	Unit
Supply voltage (over voltage protection see page 4)	V_{bb}	42	V
Supply voltage for short circuit protection, $T_{j,start}$ =-40 ...+150°C: (see diagram on page 10)	V_{bb}	34	V
Load current (short circuit current, see page 5)	I_L	self-limited	A
Load dump protection $V_{LoadDump} = V_A + V_S$, $V_A = 13.5\,V$ $R_I{}^{5)} = 2\,\Omega$, $R_L = 0.54\,\Omega$, $t_d = 200\,ms$, IN, IS = open or grounded	$V_{Load\ dump}{}^{6)}$	75	V
Operating temperature range	T_j	-40 ...+150	°C
Storage temperature range	T_{stg}	-55 ...+150	
Power dissipation (DC), $T_C \leq 25\ °C$	P_{tot}	170	W
Inductive load switch-off energy dissipation, single pulse $V_{bb} = 12V$, $T_{j,start} = 150°C$, $T_C = 150°C$ const., $I_L = 20\,A$, $Z_L = 7.5\,mH$, $0\,\Omega$, see diagrams on page 10	E_{AS}	1.5	J
Electrostatic discharge capability (ESD) Human Body Model acc. MIL-STD883D, method 3015.7 and ESD assn. std. S5.1-1993, C = 100 pF, R = 1.5 kΩ	V_{ESD}	4	kV
Current through input pin (DC)	I_{IN}	+15 , -250	mA
Current through current sense status pin (DC)	I_{IS}	+15 , -250	
see internal circuit diagrams on page 8 and 9			

[3] Not shorting all outputs will considerably increase the on-state resistance, reduce the peak current capability and decrease the current sense accuracy

[4] Otherwise add up to 0.7 mΩ (depending on used length of the pin) to the R_{ON} if the pin is used instead of the tab.

[5] R_I = internal resistance of the load dump test pulse generator.

[6] $V_{Load\ dump}$ is setup without the DUT connected to the generator per ISO 7637-1 and DIN 40839.

Thermal Characteristics

Parameter and Conditions	Symbol	Values			Unit
		min	typ	max	
Thermal resistance chip - case:	R_{thJC} [7]	--	--	0.75	K/W
junction - ambient (free air):	R_{thJA}	--	60	--	
SMD version, device on PCB [8]:		--	33	40	

Electrical Characteristics

Parameter and Conditions	Symbol	Values			Unit
at T_j = -40 ... +150 °C, V_{bb} = 12 V unless otherwise specified		min	typ	max	

Load Switching Capabilities and Characteristics

Parameter and Conditions	Symbol	Values			Unit
On-state resistance (Tab to pins 1,2,6,7, see measurement circuit page 7) I_L = 20 A, T_j = 25 °C:	R_{ON}	--	4.4	6.0	mΩ
V_{IN} = 0, I_L = 20 A, T_j = 150 °C:			7.9	10.5	
I_L = 90 A, T_j = 150 °C:			--	10.7	
V_{bb} = 6V [9], I_L = 20 A, T_j = 150 °C:	$R_{\text{ON(Static)}}$	--	10	17	
Nominal load current [10] (Tab to pins 1, 2, 6, 7) ISO 10483-1/6.7: V_{ON} = 0.5 V, T_C = 85 °C [11]	$I_{\text{L(ISO)}}$	55	70	--	A
Nominal load current [10], device on PCB [8] T_A = 85 °C, $T_j \le$ 150 °C $V_{\text{ON}} \le$ 0.5 V,	$I_{\text{L(NOM)}}$	13.6	17	--	A
Maximum load current in resistive range (Tab to pins 1, 2, 6, 7) V_{ON} = 1.8 V, T_C = 25 °C:	$I_{\text{L(Max)}}$	250	--	--	
see diagram on page 13 V_{ON} = 1.8 V, T_C = 150 °C:		150	--	--	A
Turn-on time [12] I_{IN} ⌐ to 90% V_{OUT}:	t_{on}	100	--	420	µs
Turn-off time I_{IN} ⌐ to 10% V_{OUT}:	t_{off}	30	--	110	
R_L = 1 Ω , T_j = -40...+150°C					
Slew rate on [12] (10 to 30% V_{OUT}) R_L = 1 Ω , T_J = 25 °C	dV/dt$_{\text{on}}$	--	0.7	--	V/µs
Slew rate off [12] (70 to 40% V_{OUT}) R_L = 1 Ω , T_J = 25 °C	-dV/dt$_{\text{off}}$	--	1.1	--	V/µs

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[7] Thermal resistance R_{thCH} case to heatsink (about 0.5 ... 0.9 K/W with silicone paste) not included!
[8] Device on 50mm*50mm*1.5mm epoxy PCB FR4 with 6cm^2 (one layer, 70µm thick) copper area for V_{bb} connection. PCB is vertical without blown air.
[9] Decrease of V_{bb} below 10 V causes slowly a dynamic increase of R_{ON} to a higher value of $R_{\text{ON(Static)}}$. As long as V_{bIN} > $V_{\text{bIN(u) max}}$, R_{ON} increase is less than 10 % per second for T_J < 85 °C.
[10] not subject to production test, specified by design
[11] T_J is about 105°C under these conditions.
[12] See timing diagram on page 14.

Parameter and Conditions	Symbol	Values			Unit
at T_j = -40 ... +150 °C, V_{bb} = 12 V unless otherwise specified		min	typ	max	

Inverse Load Current Operation

Parameter and Conditions		Symbol	min	typ	max	Unit
On-state resistance (Pins 1, 2, 6, 7 to pin 4)						
V_{bIN} = 12 V, I_L = -20 A $\quad T_j$ = 25 °C:		$R_{ON(inv)}$	--	4.4	6.0	mΩ
see diagram on page 10 $\quad T_j$ = 150 °C:				7.9	10.5	
Nominal inverse load current (Pins 1, 2, 6, 7 to Tab)		$I_{L(inv)}$	55	70	--	A
V_{ON} = -0.5 V, T_C = 85 °C[11]						
Drain-source diode voltage (V_{out} > V_{bb})		$-V_{ON}$	--	0.6	--	V
I_L = -20 A, I_{IN} = 0, T_j = +150°C						

Operating Parameters

Parameter and Conditions		Symbol	min	typ	max	Unit
Operating voltage (V_{IN} = 0V) [13]		$V_{bb(on)}$	5.0	--	34	V
Under voltage shutdown [14]		$V_{bIN(u)}$	1.5	3.0	4.5	V
Under voltage start of charge pump see diagram page 15		$V_{bIN(ucp)}$	3.0	4.5	6.0	V
Over voltage protection [15] $\quad T_j$ = -40°C:		$V_{Z,IN}$	60	--	--	V
I_{bb} = 15 mA $\quad T_j$ = 25...+150°C:			62	66	--	
Standby current $\quad T_j$ = -40...+25°C:		$I_{bb(off)}$	--	15	25	µA
I_{IN} = 0 $\quad T_j$ = 150°C:			--	25	50	

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[13] If the device is turned on before a V_{bb}-decrease, the operating voltage range is extended down to $V_{bIN(u)}$. For all voltages 0 ... 34 V the device provides embedded protection functions against overtemperature and short circuit.

[14] V_{bIN} = V_{bb} - V_{IN} see diagram on page 7. When V_{bIN} increases from less than $V_{bIN(u)}$ up to $V_{bIN(ucp)}$ = 5 V (typ.) the charge pump is not active and $V_{OUT} \approx V_{bb}$ - 3 V.

[15] See also $V_{ON(CL)}$ in circuit diagram on page 9.

Parameter and Conditions	Symbol	Values			Unit
at T_j = -40 ... +150 °C, V_{bb} = 12 V unless otherwise specified		min	typ	max	

Protection Functions [16]

Parameter and Conditions	Symbol	min	typ	max	Unit
Short circuit current limit (Tab to pins 1, 2, 6, 7)					
V_{ON} = 12 V, time until shutdown max. 350 µs T_c =-40°C:	$I_{L(SC)}$	--	110	--	A
T_c =25°C:	$I_{L(SC)}$	--	130	180	
T_c =+150°C:	$I_{L(SC)}$	65	115	--	
Short circuit shutdown delay after input current positive slope, V_{ON} > $V_{ON(SC)}$ min. value valid only if input "off-signal" time exceeds 30 µs	$t_{d(SC)}$	80	--	350	µs
Output clamp [17] I_L= 40 mA: (inductive load switch off) see diagram Ind. and overvolt. output clamp page 8	$-V_{OUT(CL)}$	14	16.5	20	V
Output clamp (inductive load switch off) at V_{OUT} = V_{bb} - $V_{ON(CL)}$ (e.g. over voltage) I_L= 40 mA	$V_{ON(CL)}$	39	42	47	V
Short circuit shutdown detection voltage (pin 4 to pins 1,2,6,7)	$V_{ON(SC)}$	--	6	--	V
Thermal overload trip temperature	T_{jt}	150	--	--	°C
Thermal hysteresis	ΔT_{jt}	--	10	--	K

Reverse Battery

Parameter and Conditions	Symbol	min	typ	max	Unit
Reverse battery voltage [18]	$-V_{bb}$	--	--	16	V
On-state resistance (Pins 1 ,2 ,6 ,7 to pin 4) T_j = 25 °C: V_{bb} =-12V, V_{IN}=0, I_L = -20 A, R_{IS} =1 kΩ T_j = 150 °C:	$R_{ON(rev)}$	--	5.4 8.9	7.0 12.3	mΩ
Integrated resistor in V_{bb} line	R_{bb}	--	120	--	Ω

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[16]   Integrated protection functions are designed to prevent IC destruction under fault conditions described in the data sheet. Fault conditions are considered as "outside" normal operating range. Protection functions are not designed for continuous repetitive operation.

[17]   This output clamp can be "switched off" by using an additional diode at the IS-Pin (see page 8). If the diode is used, V_{OUT} is clamped to V_{bb}- $V_{ON(CL)}$ at inductive load switch off.

[18]   The reverse load current through the intrinsic drain-source diode has to be limited by the connected load (as it is done with all polarity symmetric loads). Note that under off-conditions (I_{IN} = I_{IS} = 0) the power transistor is not activated. This results in raised power dissipation due to the higher voltage drop across the intrinsic drain-source diode. The temperature protection is not active during reverse current operation! Increasing reverse battery voltage capability is simply possible as described on page 9.

Parameter and Conditions	Symbol	Values			Unit
at T_j = -40 ... +150 °C, V_{bb} = 12 V unless otherwise specified		min	typ	max	

Diagnostic Characteristics

Parameter and Conditions	Symbol	min	typ	max	Unit
Current sense ratio, $\quad I_L$ = 90 A, T_j =-40°C: static on-condition, $\qquad T_j$ =25°C: $k_{ILIS} = I_L : I_{IS}$, $\qquad\quad T_j$ =150°C: $V_{ON} < 1.5\,V$ [19), $\quad I_L$ = 20 A, T_j =-40°C: $V_{IS} < V_{OUT}$ - 5V, $\qquad T_j$ =25°C: $V_{bIN} > 4.0\,V$ $\qquad\qquad T_j$ =150°C: see diagram on page 12 $\quad I_L$ = 10 A, T_j =-40°C: $\qquad\qquad\qquad\qquad T_j$ =25°C: $\qquad\qquad\qquad\qquad T_j$ =150°C: $\qquad\qquad\quad I_L$ = 4 A, T_j =-40°C: $\qquad\qquad\qquad\qquad T_j$ =25°C: $\qquad\qquad\qquad\qquad T_j$ =150°C:	k_{ILIS}	12 500 12 500 11 500 12 500 12 000 11 500 12 500 11 500 11 500 11 000 11 000 11 200	14 200 13 700 13 000 14 500 14 000 13 400 15 000 14 300 13 500 18 000 15 400 14 000	16 000 16 000 14 500 17 500 16 500 15 000 19 000 17 500 15 500 28 500 22 000 19 000	
I_{IS}=0 by I_{IN} =0 (e.g. during deenergizing of inductive loads):					
Sense current saturation	$I_{IS,lim}$	6.5	--	--	mA
Current sense leakage current $\qquad\qquad I_{IN}$ = 0:	$I_{IS(LL)}$	--	--	0.5	µA
$\qquad\qquad\qquad\qquad\qquad\qquad V_{IN}$ = 0, $I_L \le 0$:	$I_{IS(LH)}$	--	2	65	
Current sense over voltage protection $\quad T_j$ =-40°C:	$V_{Z,IS}$	60	--	--	V
$\quad I_{bb}$ = 15 mA $\qquad\qquad\qquad\qquad T_j$ = 25...+150°C:		62	66	--	
Current sense settling time [20)	$t_{s(IS)}$	--	--	500	µs

Input

Parameter and Conditions	Symbol	min	typ	max	Unit
Input and operating current (see diagram page 13) IN grounded (V_{IN} = 0)	$I_{IN(on)}$	--	0.8	1.5	mA
Input current for turn-off [21)	$I_{IN(off)}$	--	--	80	µA

[19) If V_{ON} is higher, the sense current is no longer proportional to the load current due to sense current saturation, see $I_{IS,lim}$.

[20) not subject to production test, specified by design

[21) We recommend the resistance between IN and GND to be less than 0.5 kΩ for turn-on and more than 500kΩ for turn-off. Consider that when the device is switched off (I_{IN} =0) the voltage between IN and GND reaches almost V_{bb}.

Truth Table

	Input current level	Output level	Current Sense I_{IS}	Remark
Normal operation	L H	L H	0 nominal	$=I_L / k_{ilis}$, up to $I_{IS}=I_{IS,lim}$
Very high load current	H	H	$I_{IS, lim}$	up to $V_{ON}=V_{ON(Fold\ back)}$ I_{IS} no longer proportional to I_L
Current-limitation	H	H	0	$V_{ON} > V_{ON(Fold\ back)}$ if $V_{ON}>V_{ON(SC)}$, shutdown will occur
Short circuit to GND	L H	L L	0 0	
Over temperature	L H	L L	0 0	
Short circuit to V_{bb}	L H	H H	0 <nominal [22]	
Open load	L H	Z[23] H	0 0	
Negative output voltage clamp	L	L	0	
Inverse load current	L H	H H	0 0	

L = "Low" Level; H = "High" Level
Over temperature reset by cooling: $T_j < T_{jt}$ (see diagram on page 15)
Short circuit to GND: Shutdown remains latched until next reset via input (see diagram on page 14)

Terms
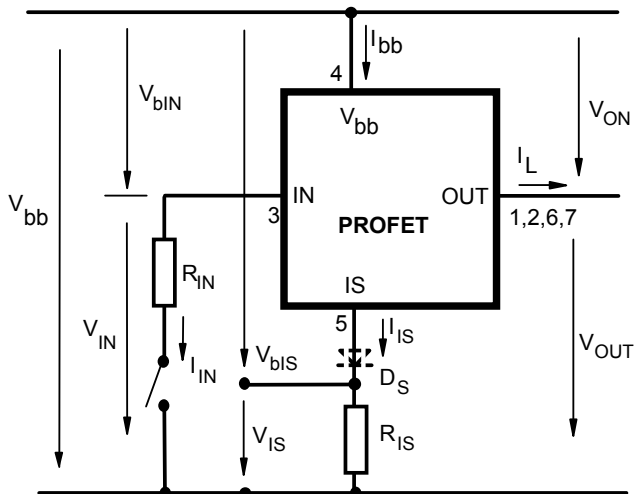
Two or more devices can easily be connected in parallel to increase load current capability.

R_ON measurement layout
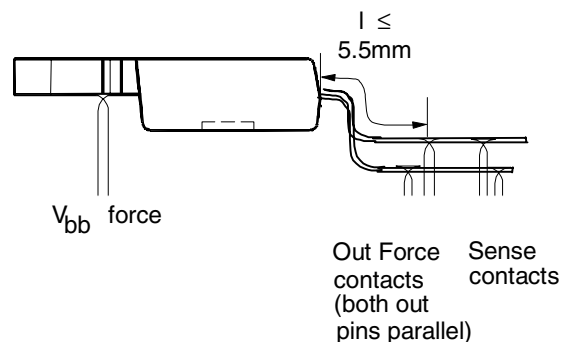
Typical R_{ON} for SMD version is about 0.2 mΩ less than straight leads due to l ≈ 2 mm

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[22] Low ohmic short to V_{bb} may reduce the output current I_L and can thus be detected via the sense current I_{IS}.
[23] Power Transistor "OFF", potential defined by external impedance.

Input circuit (ESD protection)
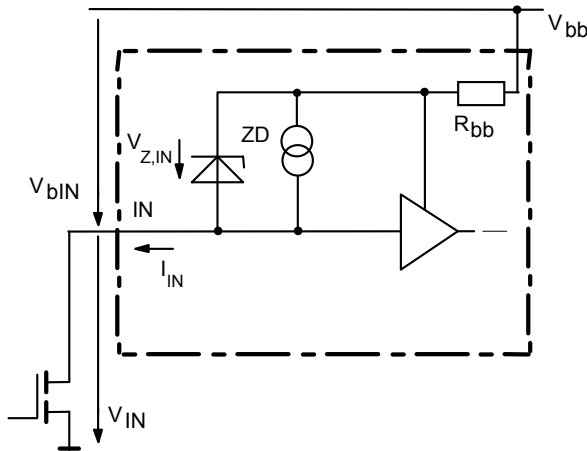
When the device is switched off ($I_{IN} = 0$) the voltage between IN and GND reaches almost V_{bb}. Use a mechanical switch, a bipolar or MOS transistor with appropriate breakdown voltage as driver.
$V_{Z,IN} = 66\,V$ (typ).

Short circuit detection

Fault Condition: $V_{ON} > V_{ON(SC)}$ (6 V typ.) and $t > t_{d(SC)}$ (80 ...350 µs).
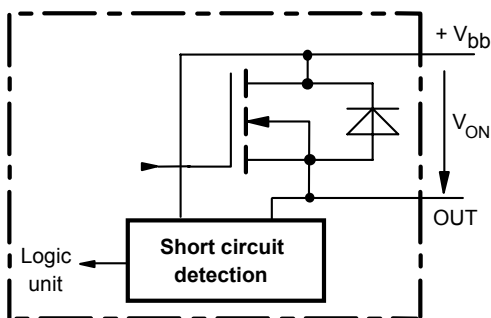
Current sense status output
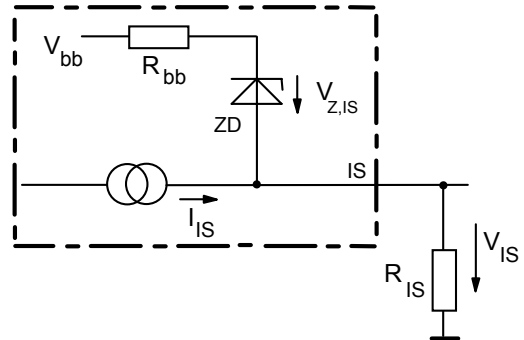
$V_{Z,IS} = 66\,V$ (typ.), $R_{IS} = 1\,k\Omega$ nominal (or $1\,k\Omega /n$, if n devices are connected in parallel). $I_S = I_L/k_{ilis}$ can be driven only by the internal circuit as long as $V_{out} - V_{IS} > 5\,V$. If you want measure load currents up to $I_{L(M)}$, R_{IS} should be less than $\dfrac{V_{bb} - 5\,V}{I_{L(M)} / K_{ilis}}$.

Note: For large values of R_{IS} the voltage V_{IS} can reach almost V_{bb}. See also over voltage protection.
If you don't use the current sense output in your application, you can leave it open.

Inductive and over voltage output clamp
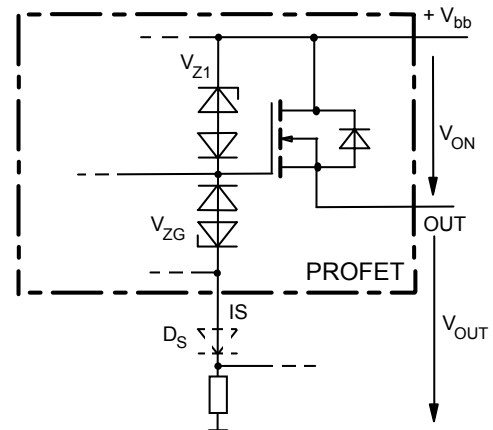
V_{ON} is clamped to $V_{ON(Cl)} = 42\,V$ typ. At inductive load switch-off without D_S, V_{OUT} is clamped to $V_{OUT(CL)} = -19\,V$ typ. via V_{ZG}. With D_S, V_{OUT} is clamped to $V_{bb} - V_{ON(CL)}$ via V_{Z1}. Using D_S gives faster deenergizing of the inductive load, but higher peak power dissipation in the PROFET. In case of a floating ground with a potential higher than 19V referring to the OUT – potential the device will switch on, if diode DS is not used.

Over voltage protection of logic part
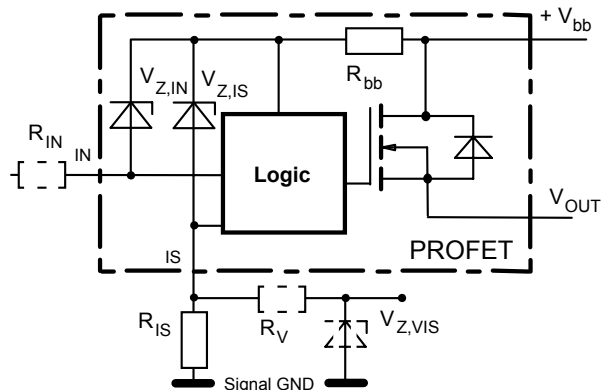
$R_{bb} = 120\,\Omega$ typ., $V_{Z,IN} = V_{Z,IS} = 66\,V$ typ., $R_{IS} = 1\,k\Omega$ nominal. Note that when over voltage exceeds $71\,V$ typ. a voltage above 5V can occur between IS and GND, if R_V, $V_{Z,VIS}$ are not used.

Reverse battery protection
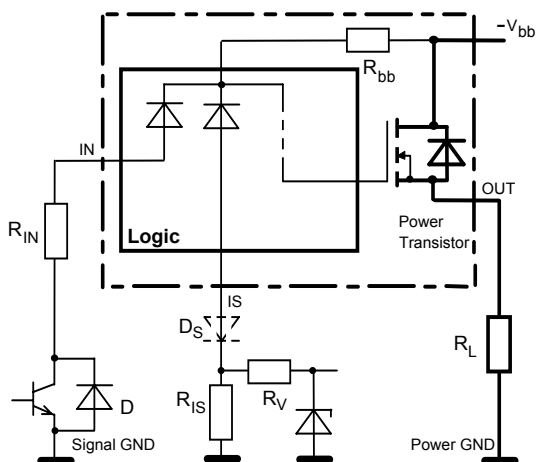
$R_V \geq 1\,k\Omega$, $R_{IS} = 1\,k\Omega$ nominal. Add R_{IN} for reverse battery protection in applications with V_{bb} above $16\,V^{18)}$; recommended value:

$$\frac{1}{R_{IN}} + \frac{1}{R_{IS}} + \frac{1}{R_V} = \frac{0.1A}{|V_{bb}| - 12V} \text{ if } D_S \text{ is not used (or}$$

$$\frac{1}{R_{IN}} = \frac{0.1A}{|V_{bb}| - 12V} \text{ if } D_S \text{ is used).}$$

To minimize power dissipation at reverse battery operation, the summarized current into the IN and IS pin should be about 120mA. The current can be provided by using a small signal diode D in parallel to the input switch, by using a MOSFET input switch or by proper adjusting the current through R_{IS} and R_V.

V_{bb} disconnect with energized inductive load

Provide a current path with load current capability by using a diode, a Z-diode, or a varistor. ($V_{ZL} < 72$ V or $V_{Zb} < 30$ V if $R_{IN}=0$). For higher clamp voltages currents at IN and IS have to be limited to 250 mA.

Version a:
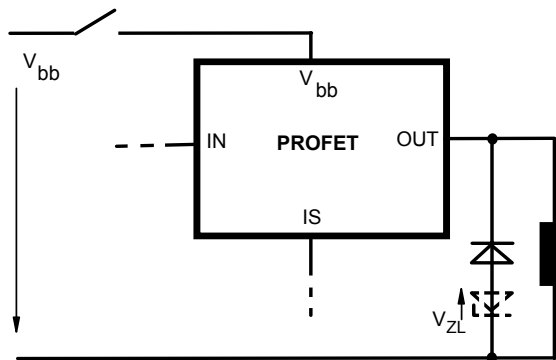
Version b:
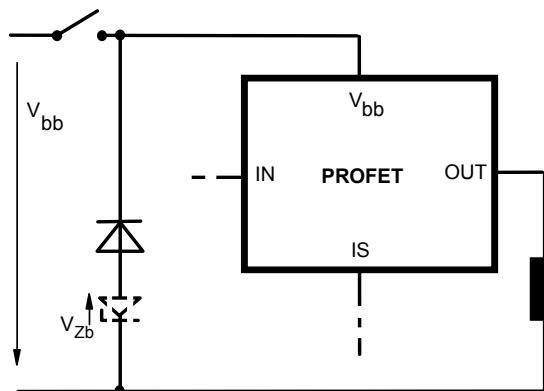
Note that there is no reverse battery protection when using a diode without additional Z-diode V_{ZL}, V_{Zb}.

Version c: Sometimes a necessary voltage clamp is given by non inductive loads R_L connected to the same switch and eliminates the need of clamping circuit:
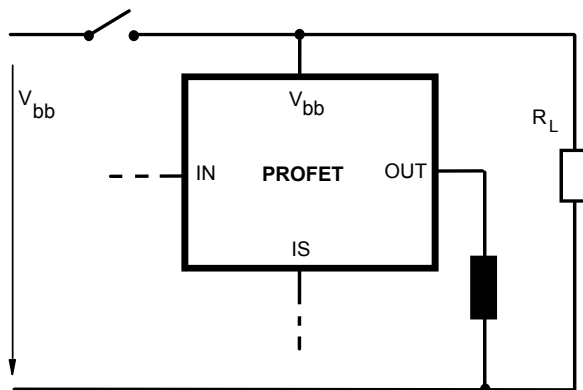
Inverse load current operation
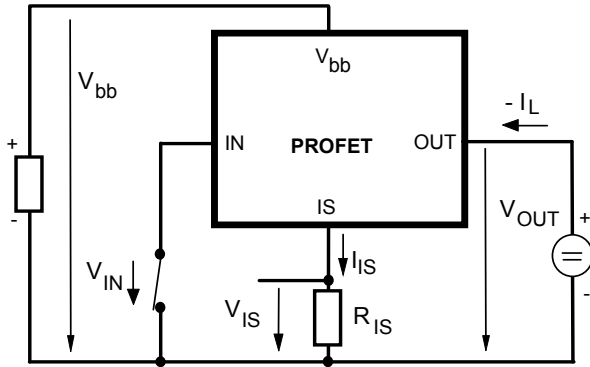
The device is specified for inverse load current operation ($V_{OUT} > V_{bb} > 0V$). The current sense feature is not available during this kind of operation ($I_{IS} = 0$). With $I_{IN} = 0$ (e.g. input open) only the intrinsic drain source diode is conducting resulting in considerably increased power dissipation. If the device is switched on ($V_{IN} = 0$), this power dissipation is decreased to the much lower value $R_{ON(INV)} * I^2$ (specifications see page 4).

Note: *Temperature protection during inverse load current operation is not possible!*

Inductive load switch-off energy dissipation
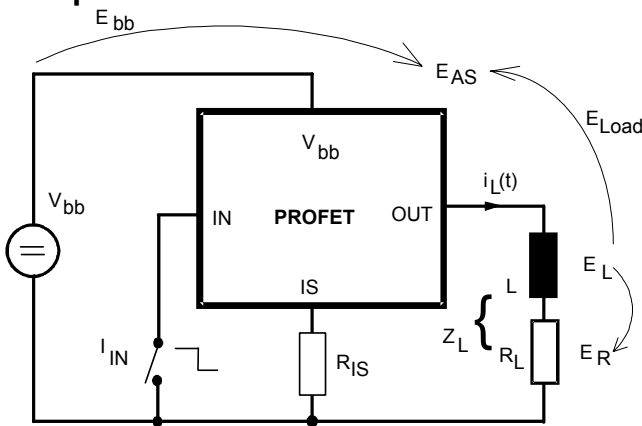
Energy stored in load inductance:

$$E_L = {}^1/_2 \cdot L \cdot I_L^2$$

While demagnetizing load inductance, the energy dissipated in PROFET is

$$E_{AS} = E_{bb} + E_L - E_R = \int V_{ON(CL)} \cdot i_L(t) \, dt,$$

with an approximate solution for $R_L > 0\,\Omega$:

$$E_{AS} = \frac{I_L \cdot L}{2 \cdot R_L} \left(V_{bb} + |V_{OUT(CL)}| \right) \, ln \left(1 + \frac{I_L \cdot R_L}{|V_{OUT(CL)}|} \right)$$

Maximum allowable load inductance for a single switch off

$L = f(I_L)$; $T_{j,start} = 150°C$, $V_{bb} = 12\,V$, $R_L = 0\,\Omega$

L [μH]

I_L [A]
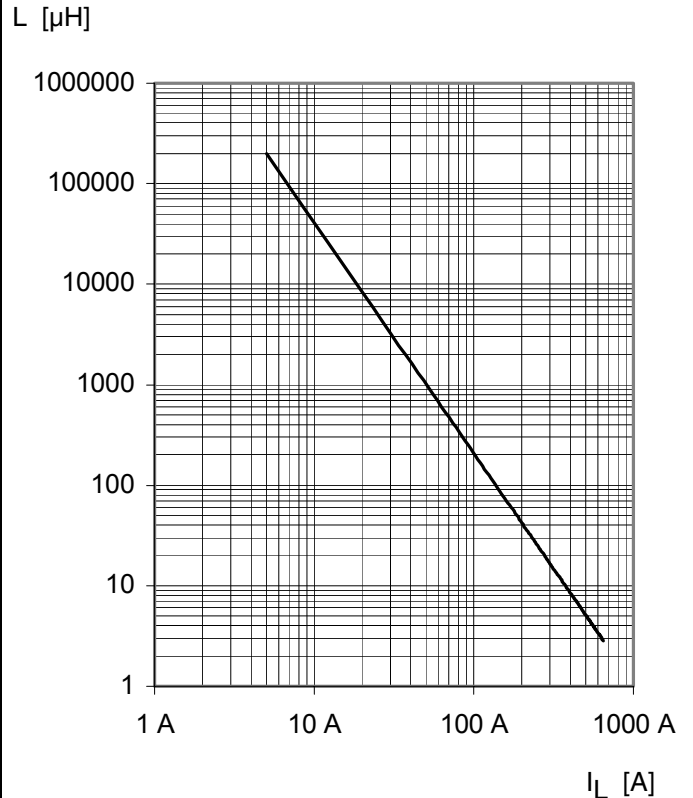
Externally adjustable current limit

If the device is conducting, the sense current can be used to reduce the short circuit current and allow higher lead inductance (see diagram above). The device will be turned off, if the threshold voltage of T2 is reached by $I_s * R_{is}$. After a delay time defined by $R_V * C_V$ T1 will be reset. The device is turned on again, the short circuit current is defined by $I_{L(SC)}$ and the device is shut down after $t_{d(SC)}$ with latch function.
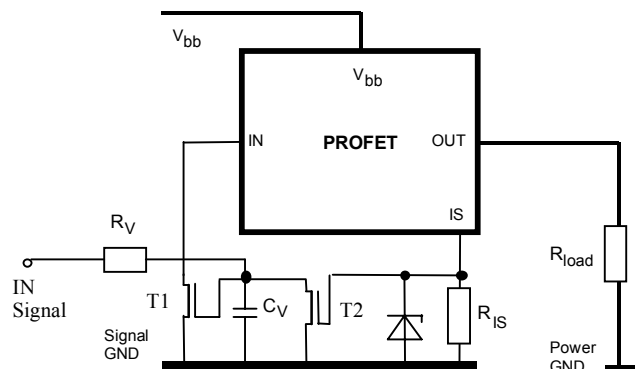
Options Overview

| Type	BTS50055-1TMB
Over temperature protection with hysteresis T_j >150 °C, latch function[24]	X
T_j >150 °C, with auto-restart on cooling	X
Short circuit to GND protection with over temperature shutdown switches off when V_{ON}>6 V typ. (when first turned on after approx. 180 μs)	X
Over voltage shutdown	-
Output negative voltage transient limit to V_{bb} - $V_{ON(CL)}$ to V_{OUT} = -19 V typ	X X[25]

---

[24] Latch except when V_{bb} - V_{OUT} < $V_{ON(SC)}$ after shutdown. In most cases V_{OUT} = 0 V after shutdown (V_{OUT} ≠ 0 V only if forced externally). So the device remains latched unless V_{bb} < $V_{ON(SC)}$ (see page 5). No latch between turn on and $t_{d(SC)}$.

[25] Can be "switched off" by using a diode D_S (see page 8) or leaving open the current sense output.

Characteristics

Current sense versus load current:
$I_{IS} = f(I_L)$, T_J= -40 ... +150 °C
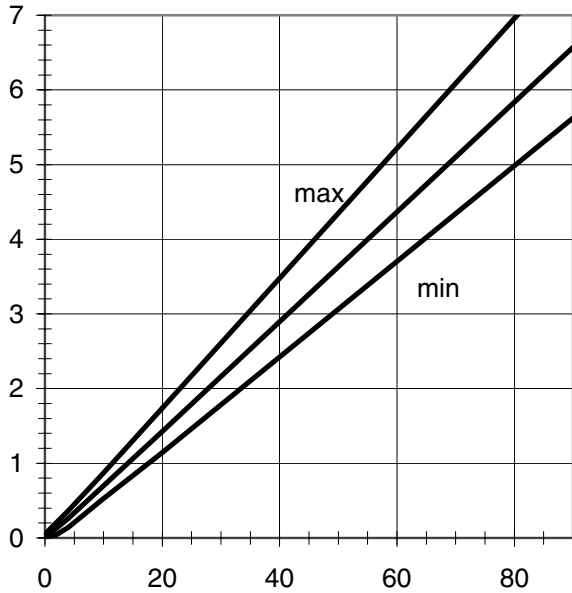
I_{IS} [mA]

I_L [A]

Current sense ratio:
$I_{IS} = f(I_L)$, T_J= 25 °C

k_{ILIS}

I_L [A]

Current sense ratio:
$K_{ILIS} = f(I_L)$, $T_J = $-40°C
k_{ilis}

I_L [A]
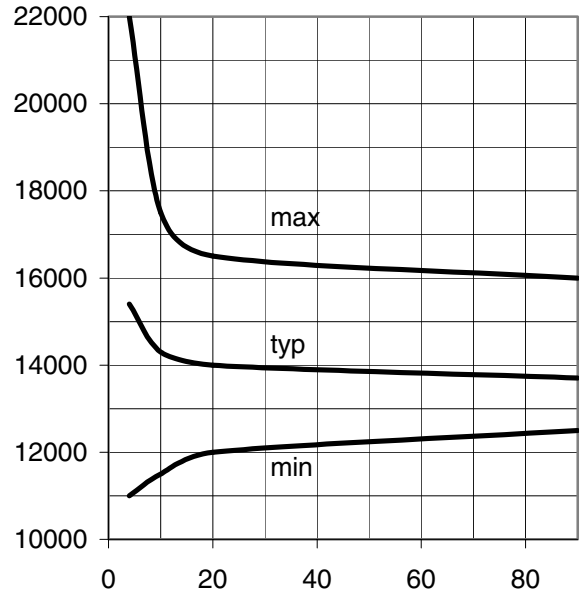
Current sense ratio:
$K_{ILIS} = f(I_L)$, $T_J = $150°C
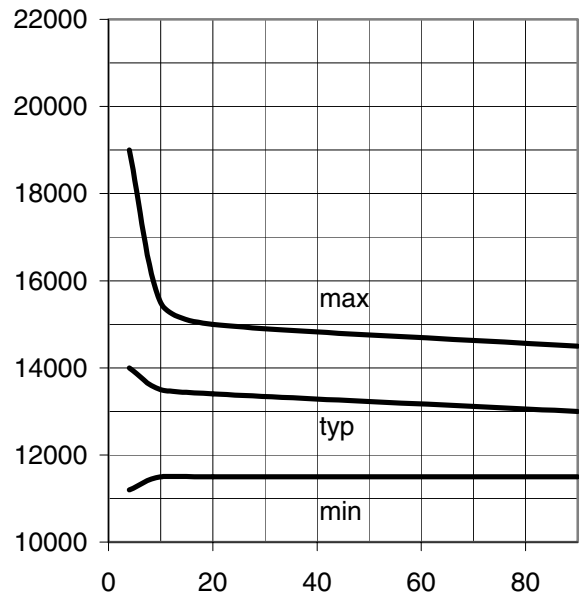
k_{ilis}

I_L [A]

Typ. current limitation characteristic
$I_L = f(V_{ON}, T_j)$

I_L [A]

$V_{ON} > V_{ON(SC)}$ only for $t < t_{d(SC)}$
(otherwise immediate shutdown)

$T_J = 25°C$

$T_J = -40°C$ $T_J = 150°C$

$V_{ON(FB)}$

V_{ON} [V]

In case of $V_{ON} > V_{ON(SC)}$ (typ. 6 V) the device will be switched off by internal short circuit detection.

Typ. on-state resistance
$R_{ON} = f(V_{bb}, T_j)$; $I_L = 20$ A; $V_{IN} = 0$

R_{ON} [mOhm]

static
dynamic

$T_j = 150°C$
85°C
25°C
-40°C

V_{bb} [V]

Typ. input current
$I_{IN} = f(V_{bIN})$, $V_{bIN} = V_{bb} - V_{IN}$
I_{IN} [mA]

V_{bIN} [V]
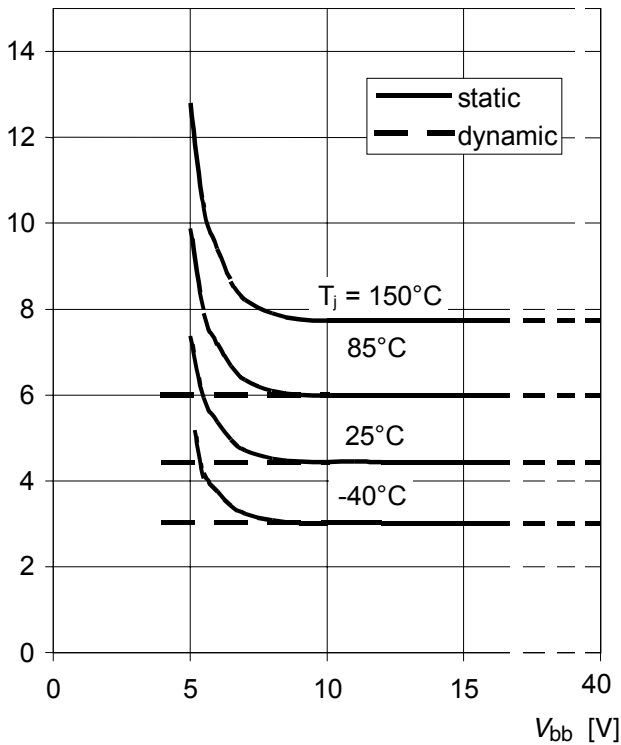
Timing diagrams

Figure 1a: Switching a resistive load, change of load current in on-condition:
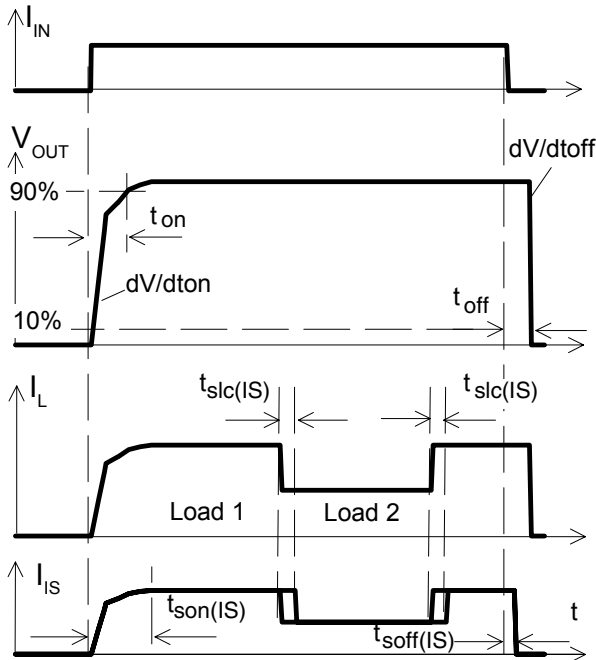
The sense signal is not valid during a settling time after turn-on/off and after change of load current.

Figure 2b: Switching motors and lamps:
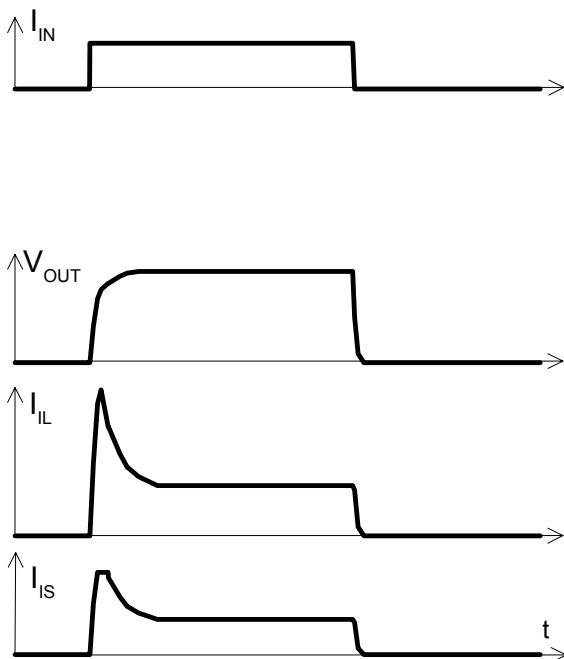
Sense current saturation can occur at very high inrush currents (see $I_{IS,lim}$ on page 6).

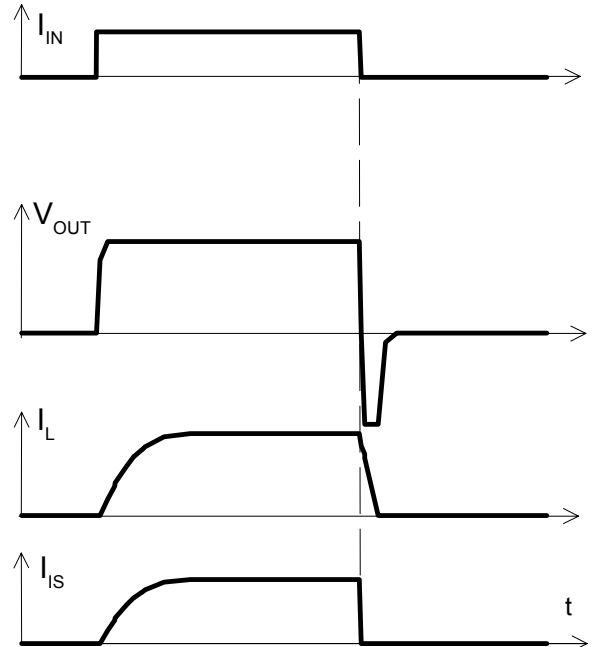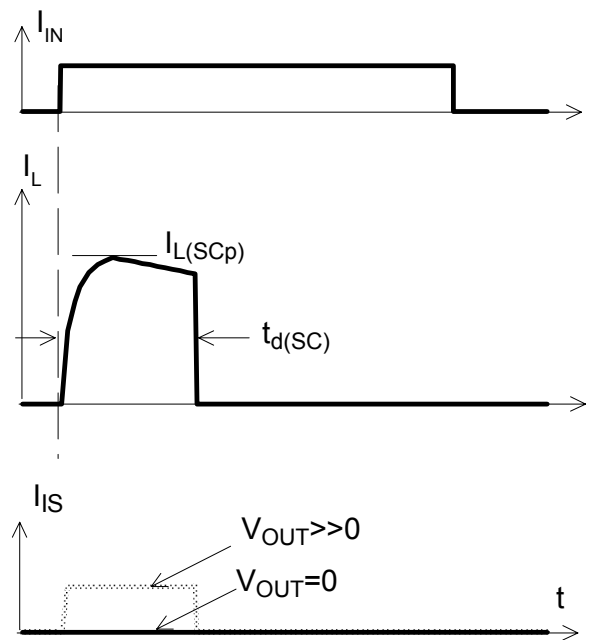**Figure 2c:** Switching an inductive load:

Figure 3d: Short circuit:
shut down by short circuit detection, reset by $I_{IN} = 0$.

Shut down remains latched until next reset via input.
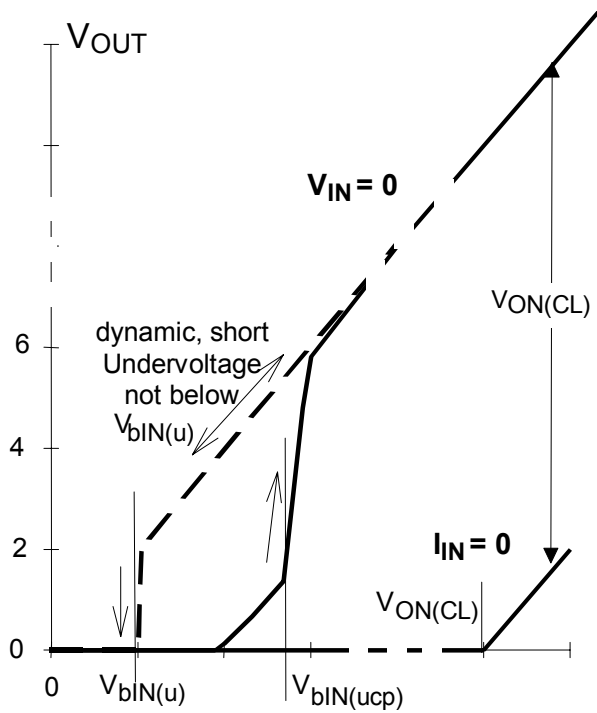
Figure 4e: Over temperature
Reset if $T_j < T_{jt}$
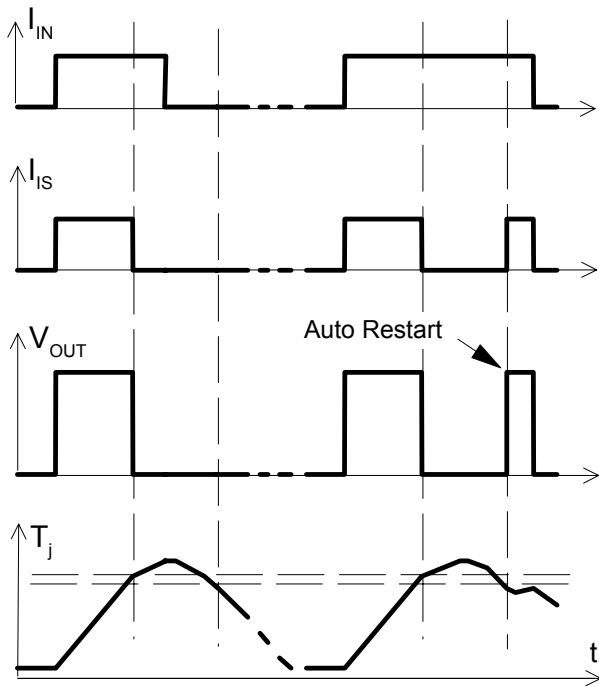
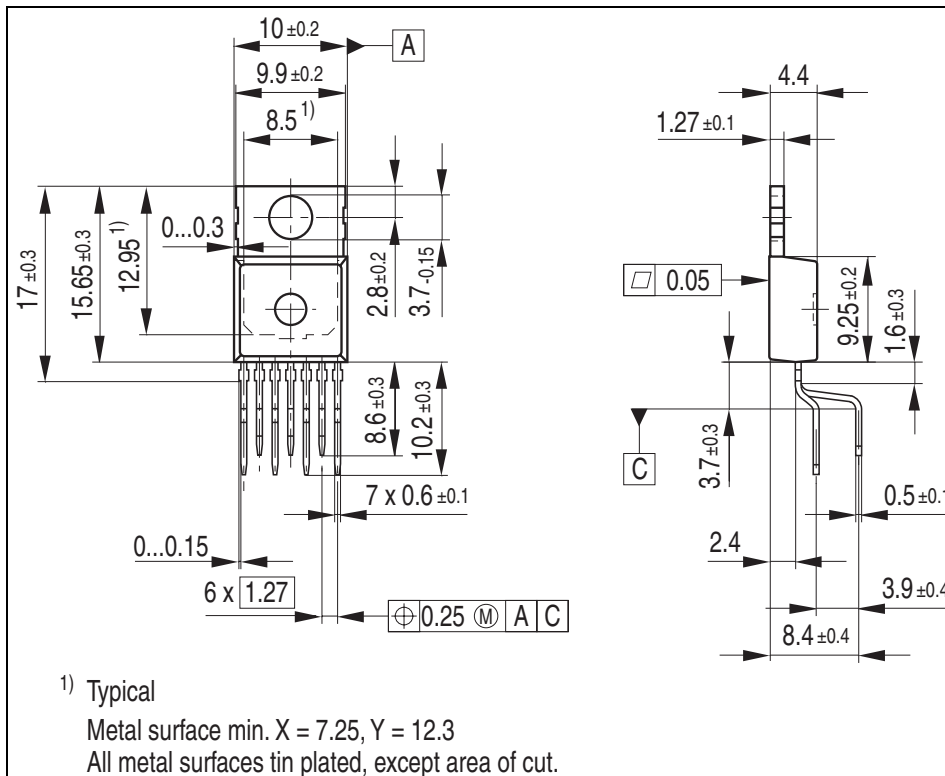**Figure 6f:** Under voltage restart of charge pump,
over voltage clamp

Package and Ordering Code

All dimensions in mm

Standard: PG-TO220-7-11

Sales Code	BTS50055-1TMB

1) Typical

Metal surface min. X = 7.25, Y = 12.3
All metal surfaces tin plated, except area of cut.

Green Product (RoHS compliant)

To meet the world-wide customer requirements for environmentally friendly products and to be compliant with government regulations the device is available as a green product. Green products are RoHS-Compliant (i.e Pb-free finish on leads and suitable for Pb-free soldering according to IPC/JEDEC J-STD-020).

Revision History

Version	Date	Changes
Rev. 1.0	2008-01-24	Initial version of data sheet. Green (RoHS compliant) variant of BTS650P

Legal Disclaimer

Information

For further information on technology, delivery terms and conditions and prices please contact your nearest Infineon Technologies Office (**www.infineon.com**).

Warnings

Due to technical requirements components may contain dangerous substances. For information on the types in question please contact your nearest Infineon Technologies Office.

Infineon Technologies Components may only be used in life-support devices or systems with the express written approval of Infineon Technologies, if a failure of such components can reasonably be expected to cause the failure of that life-support device or system, or to affect the safety or effectiveness of that device or system. Life support devices or systems are intended to be implanted in the human body, or to support and/or maintain and sustain and/or protect human life. If they fail, it is reasonable to assume that the health of the user or other persons may be endangered.